

## C0603C829BAGACTU

## Aliases (C0603C829BAGAC7867)

SMD Comm COG, Ceramic, 8.2 pF, +/-0.1 pF, 250 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603



Click here for the 3D model.

0603
1.6mm +/-0.15mm
0.8mm +/-0.15mm
0.8mm +/-0.07mm
0.7mm MIN
0.35mm +/-0.15mm

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	3700 ug
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	8.2 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	+/-0.1pF
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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